

Vishay Semiconductors

Small Signal Schottky Diodes

Features

- The SD103 series is a Metal-on-silicon Schottky barrier device which is protected by a PN junction guard ring.
- The low forward voltage drop and fast switching make it ideal for protection of MOS devices, steering, biasing and coupling diodes for fast switching and low logic level applications.
- Other applications are click suppression, efficient full wave bridges in telephone subsets, and blocking diodes in rechargeable low voltage battery systems.
- These diodes are also available in the SOD123 and SOD323 case with type designations SD103AW(S)-V...SD103CW(S)-V, and in the MiniMELF case with type designations LL103A thru LL103C.
- For general purpose applications
- · Lead (Pb)-free component
- Component in accordance with RoHS2002/95/EC and WEEE 2002/96/EC

Applications

- HF-Detector
- · Protection circuit
- Small battery charger
- AC-DC/DC-DC converters







Mechanical Data

Case: DO35 Glass case Weight: approx. 125 mg Cathode Band Color: black **Packaging Codes/Options:**

TR/10 k per 13" reel (52 mm tape), 50 k/box TAP/10 k per Ammopack (52 mm tape), 50 k/box

Parts Table

Part	Type differentiation	Ordering code	Type Marking	Remarks
SD103A	V _R = 40 V	SD103A-TR or SD103A-TAP	SD103A	Tape and Reel/Ammopack
SD103B	V _R = 30 V	SD103B-TR or SD103B-TAP	SD103B	Tape and Reel/Ammopack
SD103C	V _R = 20 V	SD103C-TR or SD103C-TAP	SD103C	Tape and Reel/Ammopack

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

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Parameter	Test condition	Part	Symbol	Value	Unit
Peak inverse voltage		SD103A	V_{R}	40	V
		SD103B	V _R	30	V
		SD103C	V _R	20	V
Power dissipation (infinite heatsink)			P _{tot}	400 ¹⁾	mW
Single cycle surge 60 Hz sine wave			I _{FSM}	15	Α

¹⁾ Valid provided that leads at a distance of 4 mm from case are kept at ambient temperature

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SD103A/103B/103C

Vishay Semiconductors



Thermal Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit	
Thermal resistance junction to ambient air		R_{thJA}	310 ¹⁾	K/W	
Junction temperature		T _j	125 ¹⁾	°C	
Storage temperature range		T _{stg}	- 55 to + 150 ¹⁾	°C	

¹⁾ Valid provided that leads at a distance of 4 mm from case are kept at ambient temperature

Electrical Characteristics

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Min	Тур.	Max	Unit
Reverse Breakdown Voltage	I _R = 50 μA	SD103A	V _(BR)	40			V
		SD103B	V _(BR)	30			V
		SD103C	V _(BR)	20			V
Leakage current	V _R = 30 V	SD103A	I _R			5	μΑ
	V _R = 20 V	SD103B	I _R			5	μΑ
	V _R = 10 V	SD103C	I _R			5	μΑ
Forward voltage drop	I _F = 20 mA		V _F			370	mV
	I _F = 200 mA		V _F			600	mV
Diode capacitance	V _R = 0 V, f = 1 MHz		C _D		50		pF
Reverse recovery time	$I_F = I_R = 50 \text{ to } 200 \text{ mA},$ recover to 0.1 I_R		t _{rr}		10		ns

Typical Characteristics

T_{amb} = 25 °C, unless otherwise specified

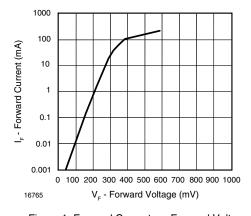


Figure 1. Forward Current vs. Forward Voltage

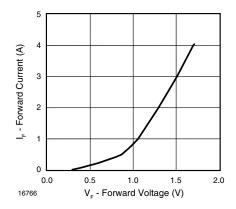


Figure 2. Forward Current vs. Forward Voltage



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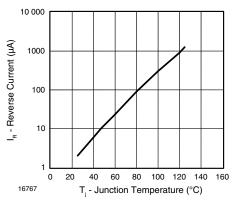


Figure 3. Reverse Current vs. Junction Temperature

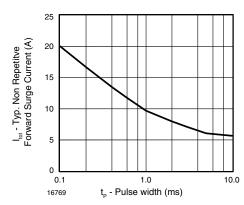


Figure 5. Typ. Non Repetitive Forward Surge Current vs. Pulse Width

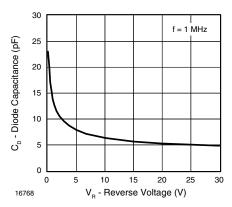
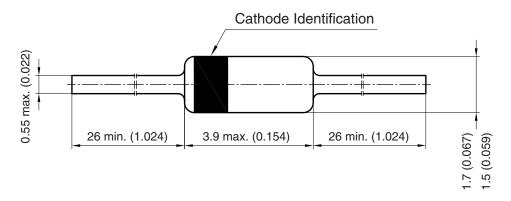


Figure 4. Diode Capacitance vs. Reverse Voltage

Package Dimensions in millimeters (inches): DO35



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SD103A/103B/103C

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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

> We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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